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Docket No. 20110 24 PCT

## COMBINED DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that:  My residence, post office address, and citizenship are as stated below under my name. I believe I am the sole (if only one name appears below), or a joint (if more than one name appears), original and first inventor of the subject matter which is claimed and for which a patent is sought on the invention
• • •
entitled: MODULE CARD AND IT'S MANUFACTURING METHOD
The specification for the above entitled invention is filed herewith.
The specification for the above entitled invention was filed previously with application serial
number, filed on
I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.  I acknowledge the duty to disclose to the Office all information known to the person to be material to patentability of this application as defined in 37, C.F.R. Section 1.56(a).
material to patentiability of this application as defined in 37, C.F.R. Section 1.30(a).
PRIORITY CLAIM
There is no claim of priority.  Claim of priority is based on the following: PCT Application # PCT/C WOO/DOSX
POWER OF ATTORNEY  As a named inventor, I hereby appoint the following attorney to prosecute this application and to
transact all related business in the Patent and Trademark Office:
Keith Kline, Registration Number 32,737  PRO-TECHTOR INTERNATIONAL SERVICES 20775 Norada Court, Saratoga, CA 95070-3018
Telephone: (408) 778-3440

authorize my attorney to accept and follow instructions from Genuine Patent & Trademark

from this application. This authorization shall remain valid until such time as I may revoke it in writing.

\_ regarding any matter related to this application or any patent that my issue

Offices in Taiwan

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(continued)

*PATENT* 

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### **DECLARATION**

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, Section 1001, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Date: 1/26 2001		Mon Nan Ht.
W	Inventor's Printed Name:	Mon Nan HO
, ,	Inventor's residence and	No.84, Taiho Road, Chupei, Hsinchu Hsien,
	Post Office Address:	Taiwan TWX
	Inventor's Citizenship:	Taiwan
Date: // >00	<del></del>	Hein Wen Tu
	Inventor's Printed Name:	Hsiu Wen TU
$\gamma i$	Inventor's residence and	No.84, Taiho Road, Chupei, Hsinchu Hsien,
000	Post Office Address:	Taiwan TWX
	Inventor's Citizenship:	Taiwan
Date: 1/1/0 >00	! 	Luo Fong FENG
Date: 1/1/2 - 200 /	Inventor's Printed Name:	Kuo Feng FENG
Date: 1/16 - 200/	Inventor's Printed Name:	Kuo Feng PENG
Date: 1/16 - 200/	Inventor's Printed Name:	' \
Date: 1/16 - 200/	Inventor's Printed Name: Inventor's residence and	No.84, Taiho Road, Chupei, Hsinchu Hsien,
	Inventor's Printed Name: Inventor's residence and Post Office Address:	No.84, Taiho Road, Chupei, Hsinchu Hsien,  Taiwan  Taiwan
	Inventor's Printed Name: Inventor's residence and Post Office Address:	No.84, Taiho Road, Chupei, Hsinchu Hsien,  Taiwan  Taiwan
	Inventor's Printed Name: Inventor's residence and Post Office Address: Inventor's Citizenship:	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan Taiwan  Yung Sheng CHIU
Date: 1/26'01  4	Inventor's Printed Name: Inventor's residence and Post Office Address: Inventor's Citizenship:  Inventor's Printed Name:	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan Taiwan  Yung Sheng CHIU
	Inventor's Printed Name: Inventor's residence and Post Office Address: Inventor's Citizenship:  Inventor's Printed Name:	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan  Taiwan  Yung Sheng CHIU  Yung Sheng CHIU

☐ Check this box if the number of inventor is over four and attach additional page of their information.

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(continued),

<u>PATENT</u>

Docket No. 2011024PCT

### **DECLARATION**

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18, United States Code, Section 1001, and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Date: 11/1/20 0	Too UV
	Inventor's Printed Name: Joe LIU
500	Inventor's residence and No.84, Taiho Road, Chupei, Hsinchu Hsien,
	Post Office Address: Taiwan
	Inventor's Citizenship: Taiwan
Date:	Nai Haa ieh
, 1)	Inventor's Printed Name: Nai Hua YEH
$\mathcal{C}^{\infty}$	Inventor's residence and No.84, Taiho Road, Chupei, Hsinchu Hsien,
	Post Office Address: Taiwan
	Inventor's Citizenship: Taiwan
	,
Date: (1/10, 6)	Wan Chron MEN
Date: (1/10, 6)	Inventor's Printed Name: Wen Chuan CHEN
Date: 4/0, 07	
Date: 1/10, 67	Inventor's Printed Name: Wen Chuan CHEN
Date: 40, 67	Inventor's Printed Name: Wen Chuan CHEN Inventor's residence and No.84, Taiho Road, Chupei, Hsinchu Hsien,
,	Inventor's Printed Name: Wen Chuan CHEN Inventor's residence and No.84, Taiho Road, Chupei, Hsinchu Hsien, Post Office Address: Taiwan
Date: 40, 61  Date: 40, 61  Story	Inventor's Printed Name: Wen Chuan CHEN Inventor's residence and No.84, Taiho Road, Chupei, Hsinchu Hsien, Post Office Address: Taiwan Inventor's Citizenship: Taiwan
,	Inventor's Printed Name: Wen Chuan CHEN Inventor's residence and No.84, Taiho Road, Chupei, Hsinchu Hsien, Post Office Address: Taiwan Inventor's Citizenship: Taiwan
,	Inventor's Printed Name: Wen Chuan CHEN Inventor's residence and No.84, Taiho Road, Chupei, Hsinchu Hsien, Post Office Address: Taiwan Inventor's Citizenship: Taiwan Inventor's Printed Name: Allis CHEN

Check this box if the number of inventor is over four and attach additional page of their information.

ADDIBUTE TECHDA

<u>PATENT</u>

Docket No.: 20/1024 PCT

# In the United States Patent and Trademark Office

	•
First/Sole Applicant: Mon Nan HO	1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1
Other Applicant(s): Hsiu Wen TU, Kuo Feng FENG, Y	ung Sheng CHIU, Joe LIU, Nai Hua YEH,
Wen Chuan Chen, and Allis CHEN	<u>1</u>
Title: MODULE CARD AND IT'S MANUFACTURING	METHOD
Small Entity Declaration - Sma	all Business Concern
I hereby declare that I am	
( ) the owner of the small business concern identified belo	· ·
(X) an officer of the small business concern empowered to	act on behalf of the concern identified below:
Name of Concern: Kingpak Technology Inc.	·
Address of Concern: No.84, Taiho Road, Chupei, I	Hsinchu Hsien , Taiwan
<i>f</i>	
13 CFR 121.3-18, and reproduced in 37 CFR 1.9(d), for purpose (b) of Title 35, United States Code, in that the number of employ does not exceed 500 persons. For purposes of this statement, (1) is the average over the previous fiscal year of the concern of the temporary basis during each of the pay periods of the fiscal year either, directly or indirectly, one concern controls or has the power to control both.	yees of the concern, including those of its affiliates the number of employees of the business concern persons employed on a full-time, part-time or r, and (2) concerns are affiliates of each other when
I hereby declare that rights under contract or law have been concern identified above with regard to the above entitled inventified herewith.	
I acknowledge a duty to file, in the above application for patent, loss of entitlement to small entity status prior to paying, or at the maintenance fee due after the date on which status as a small entity status as a small entity status as a small entity of the status as a small entity status as a small entity of the status as a small entity of th	e time of paying, the earliest of the issue fee or any
I hereby declare that all statements made herein of my own know information and belief are believed to be true; and further that the willful false statements and the like so made are punishable by fi Title 18 of the United States Code, and that such willful false state application, any patent issuing thereon, or any patent to which the	nese statements were made with the knowledge that fine or imprisonment or both, under Section 1001 of atements may jeopardize the validity of the
Burton Yang	11/26.2001.
Signature of Owner/Officer of Small Business Concern	Date of Signature
Name of Owner/Officer: Burton Yang	Title of Officer: Manager
Address of Owner/Officer: No.84, Taiho Road, Chupei, I	

PRINTER

Docket No .: 20/1024 P

#### ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration. ASSIGNOR

Assignor's Name	Assignor's Residence and/or Address	Nationality
(1)		
Mon Nan HO	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan
(2)		
Hsiu Wen TU	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan
(3)		
Kuo Feng FENG	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan
(4)		
Yung Sheng CHIU	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan

hereby sells, assigns and transfers to ASSIGNEE

Assignee's Name	Assignee's Residence and/or Address	Nationality
Kingpak Technology Inc.	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan
	•	

and the successors, assigns and legal representatives of the ASSIGNEE [check one of the following] percent (%) interest the entire right, title, and interest an undivided \_\_\_\_ in and to any and all improvements which are disclosed in the invention entitled: MODULE CARD AND IT'S MANUFACTURING METHOD and which is found in [check one of the following] (a) \( \overline{\overline (b) 🗆 U.S. patent application serial number \_\_\_\_\_\_, filed on \_\_\_\_\_\_ \_\_\_\_\_, issued on (c) U.S. patent number \_\_\_\_\_ and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuation, division, renewal, or substitute thereof, and as to Letters Patent any reissued or re-examination thereof.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNOR will communicate to ASSIGNEE or its representatives any facts known to ASSIGNOR respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid ASSIGNEE and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Assignor's Signature	Printed Name and/or Title	Date Signed
(1) Mon Nan Ho	Mon Nan HO	26 5001
(2) Hein Wen Tu	Hsiu Wen TU	1/26/2001
(3) Kup Fiend FB/UG	Kuo Feng FENG	1/20 2001
(4) Yung Sheng CHIU	Yung Sheng CHIU	1/26'01

TUUTEULE

E. IPHTA

Nationality

Docket No.: 22/1024

#### ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration, ASSIGNOR

Assignor's Name	Assignor's Residence and/or Address	Nationality
(5) Joe LIU	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan
(6) Nai Hua YÉH	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan
(7) Wen Chuan CHEN	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan
(8) Allis CHEN	No.84, Taiho Road, Chupei, Hsinchu Hsien, Taiwan	Taiwan

Assignee's Residence and/or Address

hereby sells, assigns and transfers to ASSIGNEE

Assignee's Name

Kingpak Technology Inc.	No.84, Taiho Road, Chi	upei, Hsinchu Hsien, Taiwan	Taiwan
and the successors, assigns and legal representation	entatives of the ASSIGNEE	[check one of the follo	owing]
🕱 the entire right, title, and interest	an undivided	percent (	_%) interest
in and to any and all improvements whi	ch are disclosed in the inve	ention entitled: MODULE C	ARD AND IT'S
MANUFACTURING METHOD ,	and which is found in	[check one of the following]	
(a) 🗷 U.S. patent application executed on _	11,26, 2001	······································	
(b) U.S. patent application serial number	<u>.                                    </u>	, filed on	
(c) U.S. patent number	, issued or	1	
and, in and to, all Letters Patent to be ob	tained for said invention by	the above application or any co	ontinuation, division,
renewal, or substitute thereof, and as to Lett	ers Patent any reissued or re-	examination thereof.	

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNOR will communicate to ASSIGNEE or its representatives any facts known to ASSIGNOR respecting the invention, to testify in any legal proceedings, to sign all lawful papers, to execute all divisions, continuations, substitutions, renewal and reissue applications, and to generally do those things necessary to aid ASSIGNEE and its successors and assigns to obtain and enforce proper protection for the invention in the United States and in any and all foreign countries.

Assignor's Signature	Printed Name and/or Title	Date Signed
(5) JOP. [1]	Joe LIU	1/4. 01
(6) A hatter (el	Nai Hua YEH	15/10)
(7) Wen Chuom Chen	Wen Chuan Chen	1/16, 07
(8) Alli Clin	Allis CHEN	11/26'01